

## **RFP3055-VB Datasheet** N-Channel 60 V(D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.072				
Q <sub>g</sub> max. (nC)	25				
Q <sub>gs</sub> (nC)	5.8				
Q <sub>gd</sub> (nC)	11				
Configuration	Single				

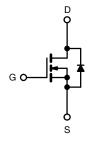
## **FEATURES**

- Dynamic dV/dt rating
- · Fast switching
- Ease of paralleling

Simple drive requirements







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	60	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	I	20		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	Ι <sub>D</sub>	12	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	68		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Maximum Power Dissipation	Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		PD	60	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering Recommendations (Peak temperature) <sup>d</sup>	for 10 s			300		
Mounting Torque	6 22 or 1			10	lbf ∙ in	
Mounting Torque	6-32 or M3 screw			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ ,  $L = 403 \mu\text{H}$ ,  $R_g = 25 \Omega$ ,  $I_{AS} = 17 \text{ A}$  (see fig. 12). c.  $I_{SD} \le 17 \text{ A}$ ,  $dI/dt \le 140 \text{ A/}\mu\text{s}$ ,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175 \text{ °C}$ .

d. 1.6 mm from case.



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	2.5	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.061	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	: V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	3.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		= 60 V, V <sub>GS</sub> = 0 V V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-		25 250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		-	0.072	-	Ω
Forward Transconductance	9 <sub>fs</sub>		= 25 V, I <sub>D</sub> = 10 A	5.5	-	-	S
Dynamic				1		<u> </u>	1
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V,$	-	640	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 V,$	-	360	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.	f = 1.0 MHz, see fig. 5 - 79			-	
Total Gate Charge	Qg			-	-	25	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	5.8	nC
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 6 and 13 -	-	-	11	1
Turn-On Delay Time	t <sub>d(on)</sub>			-	13	-	
Rise Time	t <sub>r</sub>	- V:	= 30 V, I <sub>D</sub> = 17 A,	-	58	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$t_r$ V <sub>DD</sub> = 30 V, I <sub>D</sub> = 17 A, -		25	-	ns	
Fall Time	t <sub>f</sub>			-	42	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>	package and die contact	package and center of die contact		7.5	-	- nH
Drain-Source Body Diode Characteristic	s				•		
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym showing the	bol	-	-	20	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	68	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, $I_{\rm S}$ = 17 A, $V_{\rm GS}$ = 0 V <sup>b</sup>	-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	т об ос и	17 A dl/dt 100 A / -	-	88	180	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_1 = 25 ^{\circ}C_1 I_2 = 17 \text{A}_2 \text{dI/dt} = 100 \text{A/us}$		0.64	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is doi	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

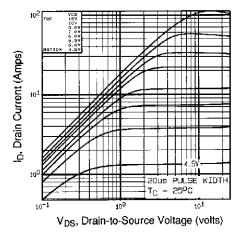


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C



Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

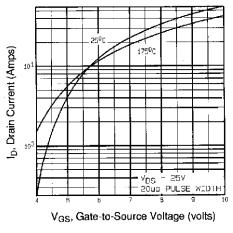


Fig. 3 - Typical Transfer Characteristics

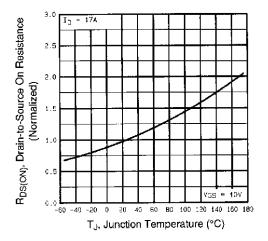


Fig. 4 - Normalized On-Resistance vs. Temperature

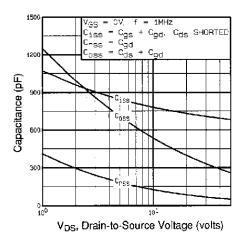


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

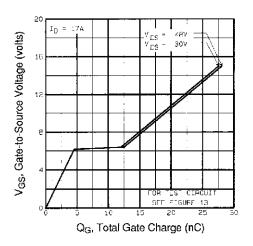


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



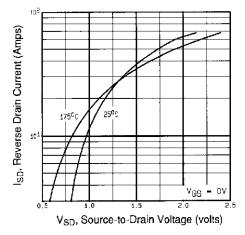


Fig. 7 - Typical Source-Drain Diode Forward Voltage

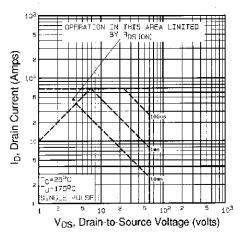


Fig. 8 - Maximum Safe Operating Area

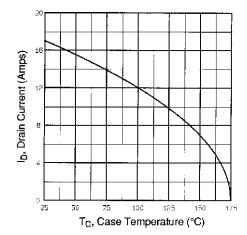


Fig. 9 - Maximum Drain Current vs. Case Temperature

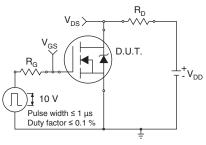


Fig. 10a - Switching Time Test Circuit

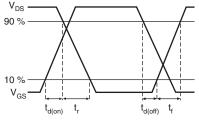
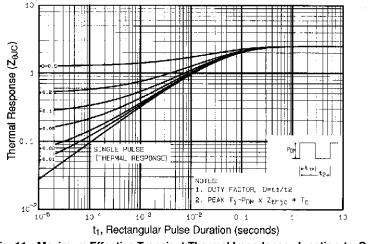


Fig. 10b - Switching Time Waveforms







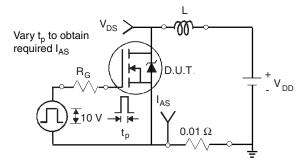


Fig. 12a - Unclamped Inductive Test Circuit

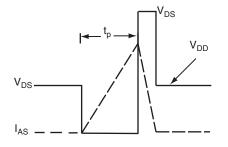


Fig. 12b - Unclamped Inductive Waveforms

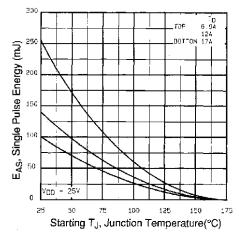


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

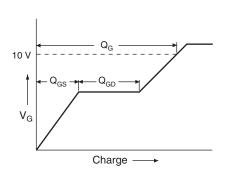


Fig. 13a - Basic Gate Charge Waveform

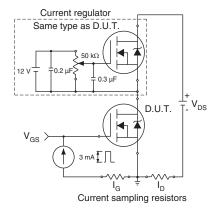
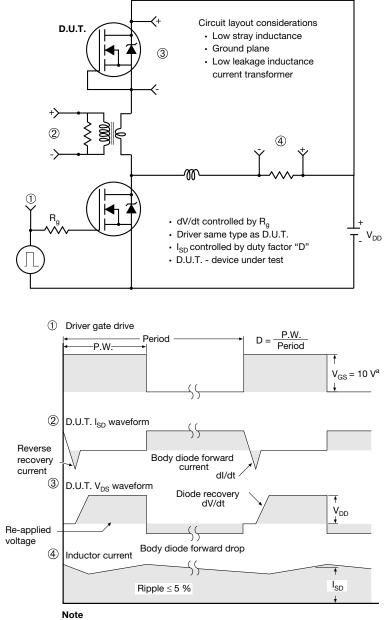


Fig. 13b - Gate Charge Test



Peak Diode Recovery dV/dt Test Circuit

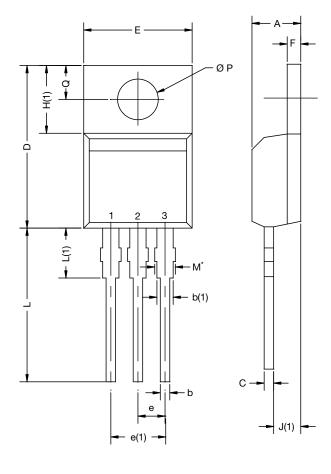


a.  $V_{GS} = 5 V$  for logic level devices

Fig. 14 - For N-Channel



# TO-220



DIM	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
-	0364-Rev. C,				

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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